P-Channel 1.8-V (G-S) MOSFET

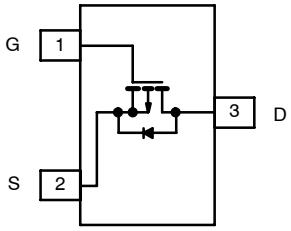
PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
−8	0.280 @ V_{GS} = −4.5 V	−0.92
	0.380 @ V_{GS} = −2.5 V	−0.79
	0.530 @ V_{GS} = −1.8 V	−0.67

FEATURES

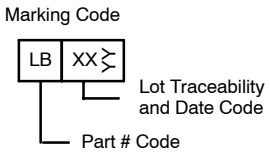
- TrenchFET® Power MOSFET: 1.8 V Rated

Pb-free
RoHS COMPLIANT

SOT-323
SC-70 (3-LEADS)



Top View



Ordering Information: Si1305DL--T1
Si1305DL--T1—E3 (Lead (Pb)-Free)

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C UNLESS OTHERWISE NOTED)					
Parameter		Symbol	5 secs	Steady State	Unit
Drain-Source Voltage		V_{DS}	−8		V
Gate-Source Voltage		V_{GS}	±8		
Continuous Drain Current (T_J = 150°C)[a]	T_A = 25°C	I_D	−0.92	−0.86	A
	T_A = 70°C		−0.74	−0.69	
Pulsed Drain Current		I_{DM}	−3		
Continuous Diode Current (Diode Conduction)[a]		I_S	−0.28	−0.24	
Maximum Power Dissipation[a]	T_A = 25°C	P_D	0.34	0.29	W
	T_A = 70°C		0.22	0.19	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	−55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient[a]	t ≤ 5 sec	R_{thJA}	315	375	°C/W
	Steady State		360	430	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	285	340	

Notes
a. Surface Mounted on 1" x 1" FR4 Board.

SPECIFICATIONS (T_J = 25°C UNLESS OTHERWISE NOTED)

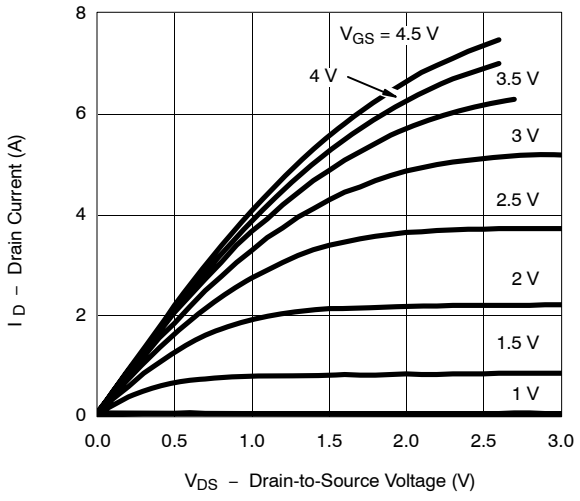
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = −250 μA	−0.45			V
Gate-Body Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ±8 V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = −8 V, V_{GS} = 0 V			−1	μA
		V_{DS} = −8 V, V_{GS} = 0 V, T_J = 70°C			−5	
On-State Drain Current[a]	$I_{D(on)}$	V_{DS} = −5 V, V_{GS} = −4.5 V	−3			A
Drain-Source On-State Resistance[a]	$r_{DS(on)}$	V_{GS} = −4.5 V, I_D = −1 A		0.230	0.280	Ω
		V_{GS} = −2.5 V, I_D = −0.5 A		0.315	0.380	
		V_{GS} = −1.8 V, I_D = −0.3 A		0.440	0.530	
Forward Transconductance[a]	g_{fs}	V_{DS} = −5 V, I_D = −1 A		3.5		S
Diode Forward Voltage[a]	V_{SD}	I_S = −0.3 A, V_{GS} = 0 V			−1.2	V
Dynamic[b]						
Total Gate Charge	Q_g	V_{DS} = −4 V, V_{GS} = −4.5 V, I_D = −1 A		2.6	4	nC
Gate-Source Charge	Q_{gs}			0.6		
Gate-Drain Charge	Q_{gd}			0.5		
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = −4 V, R_L = 4 Ω I_D ≅ −1 A, V_{GEN} = −4.5 V, R_g = 6 Ω		8	15	ns
Rise Time	t_r			55	80	
Turn-Off Delay Time	$t_{d(off)}$			17	25	
Fall Time	t_f			12	20	
Source-Drain Reverse Recovery Time	t_{rr}	I_F = −1 A, di/dt = 100 A/μs		27	45	

Notes
a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
b. Guaranteed by design, not subject to production testing.

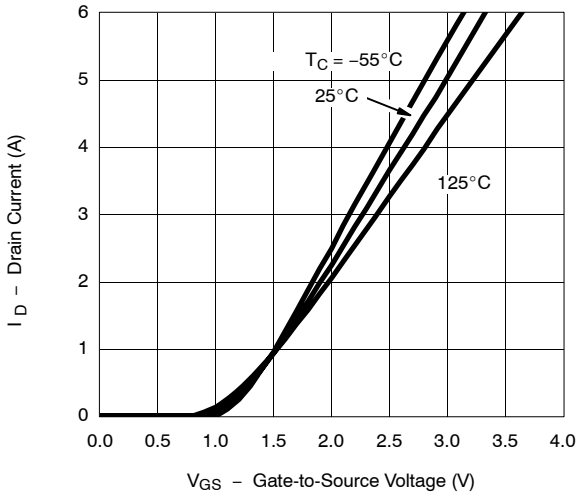
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

Output Characteristics

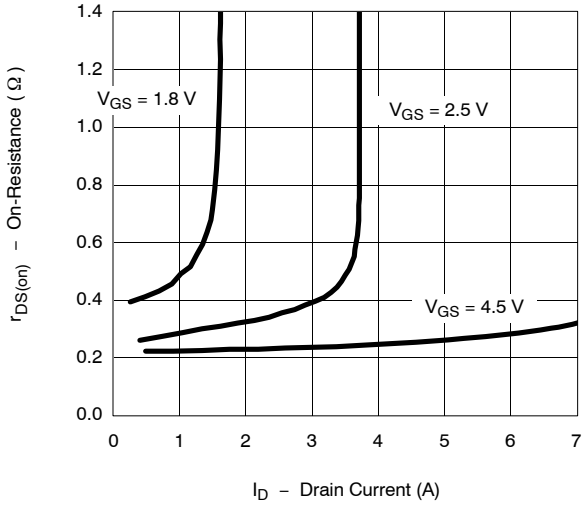


Transfer Characteristics

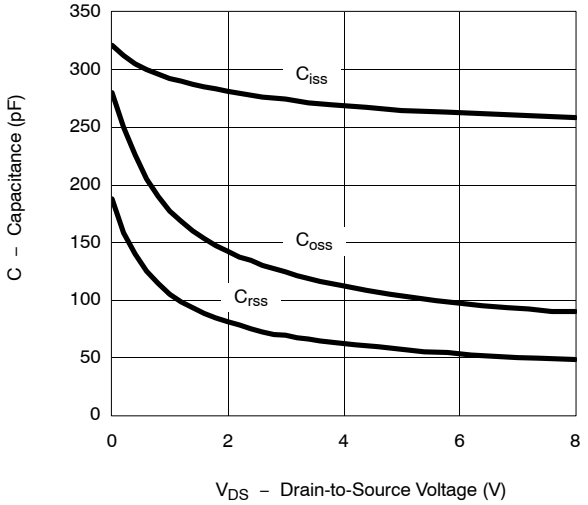


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

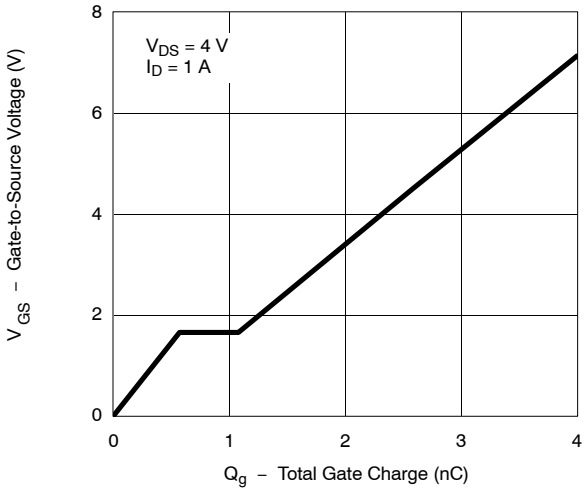
On-Resistance vs. Drain Current



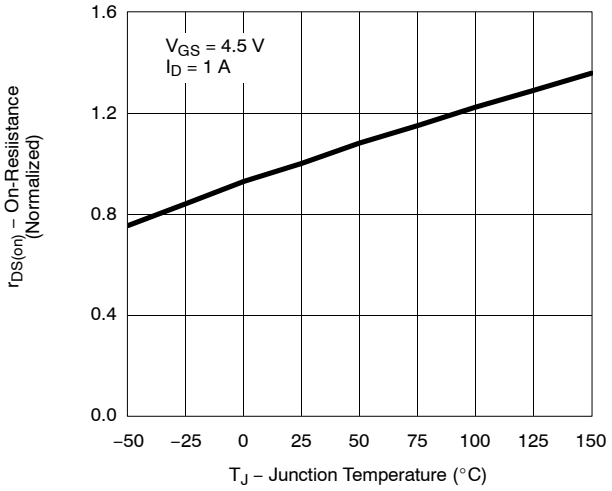
Capacitance



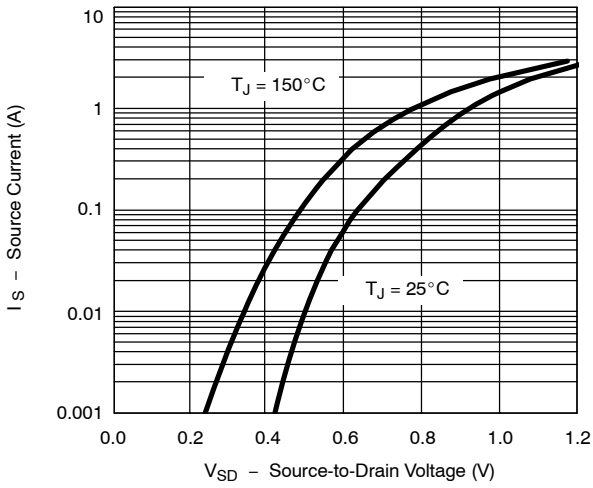
Gate Charge



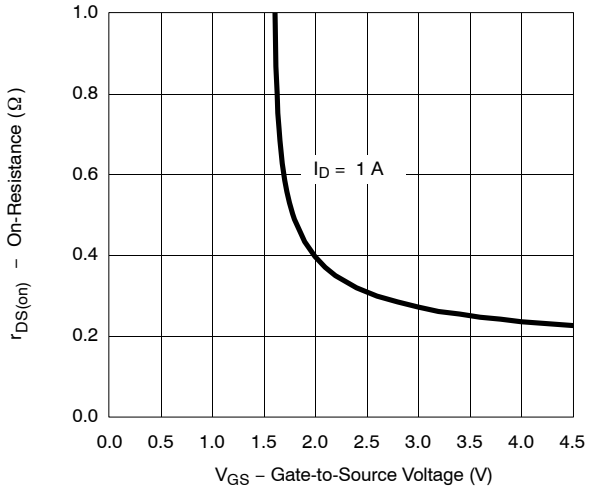
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage

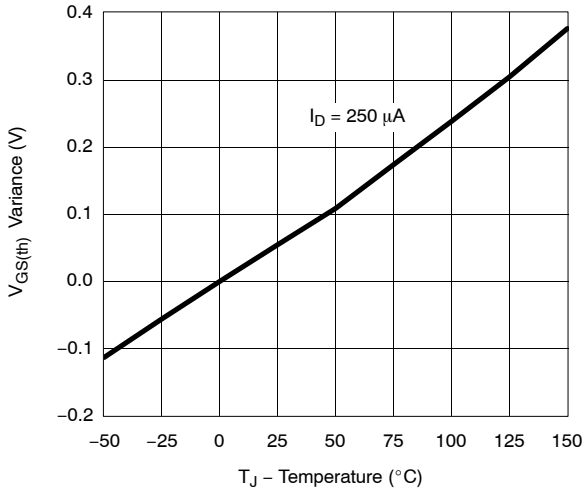


On-Resistance vs. Gate-to-Source Voltage

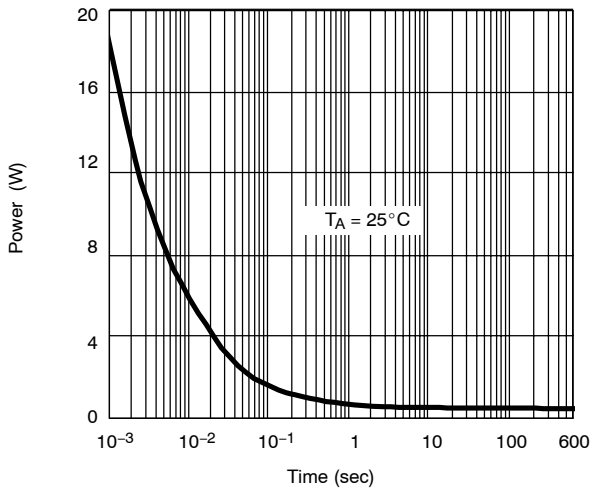


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

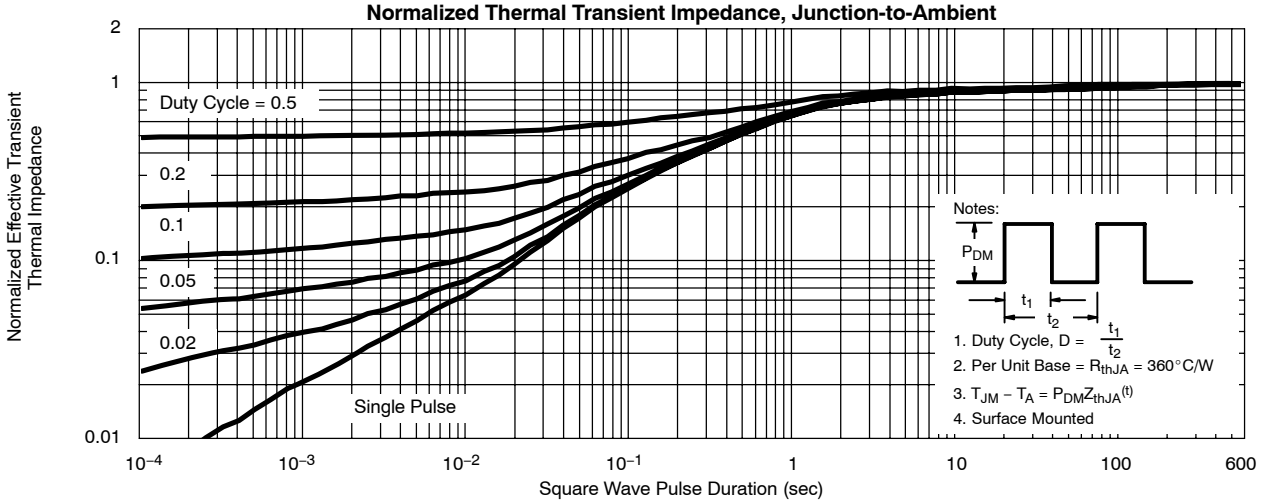
Threshold Voltage



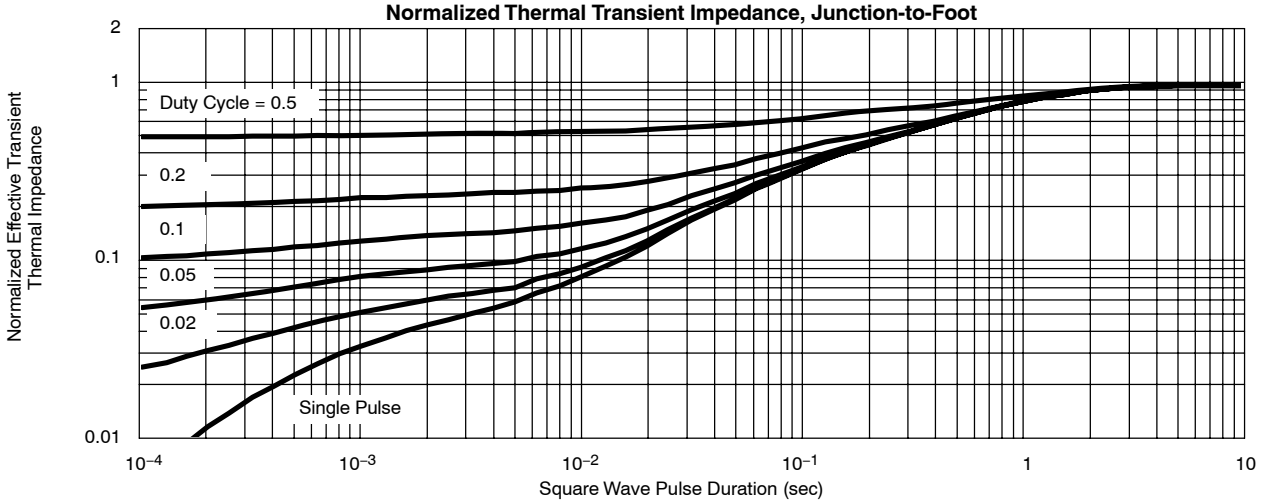
Single Pulse Power



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



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